

QUADRUPLE 2-INPUT EXCLUSIVE OR GATES

Description

The 74LVC86A provides four independent 2-input exclusive OR gates. The device is designed for operation with a power supply range of 1.65V to 5.5V. The inputs are tolerant to 5.5V allowing this device to be used in a mixed voltage environment. The device is fully specified for partial power down applications using IOFF. The IOFF circuitry disables the output preventing damaging current backflow when the device is powered down.

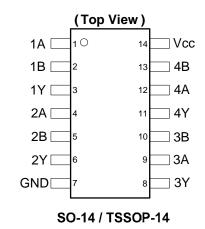
The gates perform the positive Boolean function:

$$Y = A \oplus B$$
 or $Y = \overline{A}B + A\overline{B}$

Features

- Supply Voltage Range from 1.65V to 5.5V
- Sinks 24mA at V_{CC} = 3.3V
- CMOS low power consumption
- IOFF Supports Partial-Power-Down Mode Operation
- Inputs or outputs accept up to 5.5V
- Inputs can be driven by 3.3V or 5.5V allowing for voltage translation applications.
- ESD Protection Exceeds JESD 22
 - 200-V Machine Model (A115-A)
 - 2000-V Human Body Model (A114-A)
 - Latch-Up Exceeds 250mA per JESD 78, Class II
 - Exceeds 1000-V Charged Device Model (C101C)
- Range of Package Options SO-14 and TSSOP-14
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Pin Assignments



Applications

- Voltage Level Shifting
- General Purpose Logic
- Power Down Signal Isolation
- Wide array of products such as:
 - PCs, networking, notebooks, ultrabooks, netbooks
 - Computer peripherals, hard drives, CD/DVD ROM
 - TV, DVD, DVR, set top box

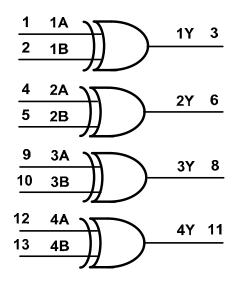
- Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
 - See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.



Pin Descriptions

Pin Number	Pin Name	Description	
1	1A	Data Input	
2	1B	Data Input	
3	1Y	Data Output	
4	2A	Data Input	
5	2B	Data Input	
6	2Y	Data Output	
7	GND	Ground	
8	3Y	Data Output	
9	ЗA	Data Input	
10	3B	Data Input	
11	4Y	Data Output	
12	4A	Data Input	
13	4B	Data Input	
14	V _{CC}	Supply Voltage	

Logic Diagram



Function Table

Inp	Output	
Α	В	Y
L	L	L
L	Н	Н
н	L	Н
Н	Н	L



Symbol	Description	Rating	Unit
ESD HBM	Human Body Model ESD Protection	2	KV
ESD CDM	Charged Device Model ESD Protection	1	KV
ESD MM	Machine Model ESD Protection	200	V
V _{CC}	Supply Voltage Range	-0.5 to 6.5	V
VI	Input Voltage Range	-0.5 to 6.5	V
Vo	Voltage applied to output in high impedance or I _{OFF} state	-0.5 to 6.5	V
Vo	Voltage applied to output in high or low state	-0.3 to V _{CC} +0.5	V
lık	Input Clamp Current VI <0	-50	mA
I _{OK}	Output Clamp Current V _O <0	-50	mA
lo	Continuous output current	50	mA
I _{CC} , I _{GND}	Continuous current through Vcc or GND	±100	mA
TJ	Operating Junction Temperature	-40 to +150	°C
T _{STG}	Storage Temperature	-65 to +150	°C
P _{TOT}	Total Power Dissipation	500	mW

Absolute Maximum Ratings (Note 4) (@T_A = +25°C, unless otherwise specified.)

Note: 4. Stresses beyond the absolute maximum may result in immediate failure or reduced reliability. These are stress values and device operation should be within recommend values.

Recommended Operating Conditions (Note 5) (@T_A = +25°C, unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	Supply Voltage		1.65	5.50	V
VI	Input Voltage		0	5.5	V
V	Output Maltana	Active Mode	0	V _{CC}	V
Vo	Output Voltage	V _{CC} = 0V; Power Down Mode	0	5.5	V
A. (A.) (Langel (magaziti a sila a su fall na fa	V _{CC} = 1.65V to 2.7V		20	D (
$\Delta t/\Delta V$ Input transition rise or fall rate		$V_{CC} = 2.7 V \text{ to } 5.5 V$		10	ns/V
T _A	Operating free-air temperature		-40	+125	°C

Note: 5. Unused inputs should be held at V_{CC} or Ground.



Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

.		THE		T _A = -40°0	C to +85°C	T _A = -40°C	to +125°C	
Symbol	Parameter	Test Conditions	V _{cc}	Min	Max	Min	Max	Unit
			1.65V to 1.95V	0.65 X V _{CC}		0.65 X V _{CC}		
.,	High-level Input		2.3V to 2.7V	1.7		1.6		.,
Vih	Voltage		2.7V to 3.6V	2.0		2.0		V
			4.5V to 5.5V	0.7 X V _{CC}		2.0		
			1.65V to 1.95V		0.35 X V _{CC}		0.35 X V_{CC}	
.,	Low-level input		2.3V to 2.7V		0.7		0.7	N/
VIL	voltage		2.7V to 3.6V		0.8		0.8	V
			4.5V to 5.5 V		0.3 X V _{CC}		0.3 X V _{CC}	
		I _{OH} = -100µА	1.65V to 3.6V	V _{CC} -0.2		V _{CC} - 0.3		
	High Level Output Voltage	I _{OH} = -4mA	1.65V	1.2				
N/		I _{OH} = -8mA	2.3V	1.9				V
V _{OH}		40 - 40	2.7V	2.2		2.05		
		I _{OH} = -12mA	3.0V	2.3		2.1		
		I _{OH} = -24mA	3.0V	2.2		2.0		
		I _{OH} = 100μA	1.65V to 5.5V		0.2		0.3	
		I _{OH} = 4mA	1.65V		0.45		0.6	
	High-level	I _{OH} = 8mA	2.3V		0.70		0.85	V
Vol	Output Voltage	1 10	2.7V		0.40		0.6	v
		I _{OH} = 12mA	3.0V		0.55		0.6	
		I _{OH} =-24mA	3.0V		0.55		0.6	
h	Input Current	V _I =GND to 5.5V	3.6V		±5		±20	μA
I _{OFF}	Power Down Leakage Current	V_1 or $V_0 =$ 0V to 3.6V	0		10		20	μA
Icc	Supply Current	$V_{I} = GND \text{ or } V_{CC} I_{O} = 0$	3.6V		10		40	μA
ΔI _{CC}	Additional Supply Current	One input at V _{CC} -0.6V Other	2.7V to 3.6V		500		5000	μA



Switching Characteristics

Cumple of	Deveryoter	Test	V	Т	_A = +25°	C	-40°C to	o +85°C	-40°C to	+125°C	Unit
Symbol	Parameter	Conditions	V _{cc}	Min	Тур	Max	Min	Max	Min	Max	Unit
	_		1.65V to1.95V	1.0	4.1	9.4	1.0	9.9	1.0	11.4	
	Propagation		2.3V to 2.7V	1.0	2.9	7.1	1.0	7.6	1.0	9.7	
τpd	t _{PD} Delay A _N or B _N to Y _N	Figure 1	2.7V	1.0	2.8	5.4	1.0	5.6	1.0	7.1	ns
	to T _N		3.0V to 3.6V	1.0	2.5	4.4	1.0	4.6	1.0	5.8	
t _{SK(0)}	Output Skew Time		3.0V to 3.6V					1.0		1.5	ns

Operating Characteristics (@T_A = +25°C, unless otherwise specified.)

	Parameter	Test Conditions	V _{CC} = 1.8V Typ	V _{CC} = 2.5V Typ	V _{CC} = 3.3V Typ	Unit
C _{pd}	Power dissipation capacitance per gate	f = 10 MHz	6.4	7.4	8.4	pF
Cı	Input Capacitance	V _i = V _{CC} – or GND	4	4	4	pF

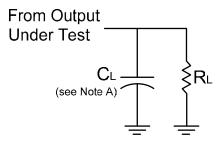
Package Characteristics

Symbol	Parameter	Test Conditions	V _{cc}	Min	Тур	Max	Unit
0	Thermal Resistance SO-14			TBD		00000	
θ_{JA}	Junction-to-Ambient	TSSOP-14	(Note 6)		159		°C/W
0	Thermal Resistance	SO-14	(Nata C)		TBD		°C/W
$\theta^{\rm JC}$	Junction-to-Case	TSSOP-14	(Note 6)		25		C/W

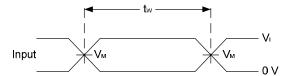
Note: 6. Test condition for SO-14 and TSSOP-14: Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.



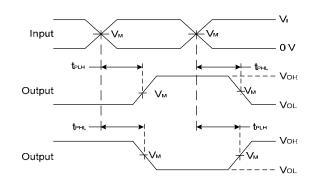
Parameter Measuement Information



V	Inputs		V.,	C	R∟	
V _{cc}	VI	t _r /t _f	V _M	CL	κL	
1.8V±0.15V	V _{CC}	≤2ns	V _{CC} /2	30pF	1ΚΩ	
2.5V±0.2V	V _{CC}	≤2ns	V _{CC} /2	30pF	500Ω	
2.7V	2.7V	≤2.5ns	1.5V	50pF	500Ω	
3.3V±0.3V	2.7V	≤2.5ns	1.5V	50pF	500Ω	



Voltage Waveform Pulse Duration



Voltage Waveform Propagation Delay Times Inverting and Non Inverting Outputs

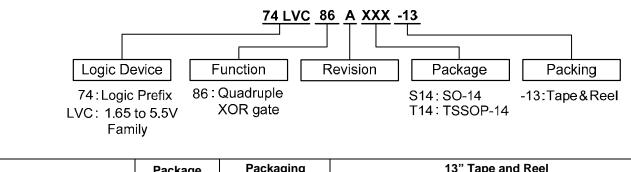
Notes: A . Includes test lead and test apparatus capacitance.

- B. All pulses are supplied at pulse repetition rate ≤ 10 MHzC. Inputs are measured separately one transition per measurement
- D. t_{PLH} and t_{PHL} are the same as t_{PD}

Figure 1. Load Circuit and Voltage Waveforms



Ordering Information

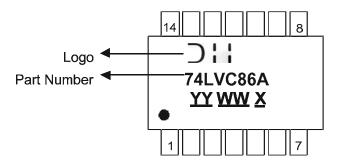


	Device	Package	Packaging	13" Tape	and Reel
	Device	Code	(Note 7)	Quantity	Part Number Suffix
Pb.	74LVC86AS14-13	S14	SO-14	2500/Tape & Reel	-13
PD.	74LVC86AT14-13	T14	TSSOP-14	2500/Tape & Reel	-13

Notes: 7. The taping orientation and tape details can be found at http://www.diodes.com/datasheets/ap02007.pdf

Marking Information

(1) SO-14, TSSOP-14



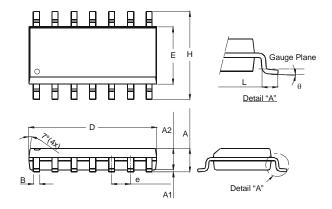
<u>YY</u> : Year : 08, 09,10~ <u>WW</u> : Week : 01~52; 52 represents 52 and 53 week <u>X</u> : Internal Code

Part Number	Package
74LVC86AS14	SO-14
74LVC86AT14	TSSOP-14



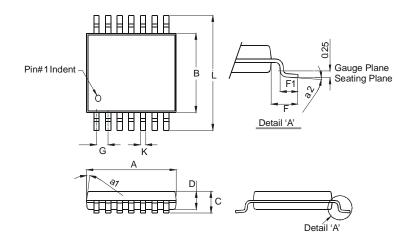
Package Outline Dimensions (All dimensions in mm.)

Package Type: SO-14



	SO-14						
Dim	Min	Max					
Α	1.47	1.73					
A1	0.10	0.25					
A2	1.45	Тур					
В	0.33	0.51					
D	8.53	8.74					
Е	3.80	3.99					
е	1.27	Тур					
Н	5.80	6.20					
L	0.38	1.27					
θ	0°	8°					
All Di	mensions	s in mm					

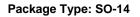
Package Type: TSSOP-14

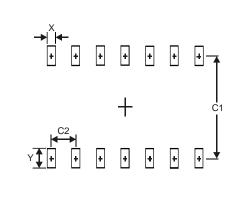


TSSOP-14		
Dim	Min	Max
a1	7° (4X)	
a2	0°	8°
Α	4.9	5.10
В	4.30	4.50
С		1.2
D	0.8	1.05
F	1.00 Тур	
F1	0.45	0.75
G	0.65 Тур	
К	0.19	0.30
L	6.40 Typ	
All Dimensions in mm		



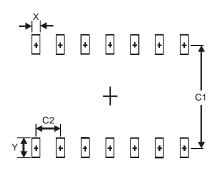
Suggested Pad Layout





Dimensions	Value (in mm)
Х	0.60
Y	1.50
C1	5.4
C2	1.27

Package Type: TSSOP-14



Dimensions	Value (in mm)
Х	0.45
Y	1.45
C1	5.9
C2	0.65



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